<u>MOSFET</u> – Power, Single N-Channel, μ**8FL** 30 V, 4.2 mΩ, 71 A

Features

- Low R_{DS(on)} to Minimize Conduction Losses
- Low Capacitance to Minimize Driver Losses
- Optimized Gate Charge to Minimize Switching Losses
- NVTFS4C06NWF Wettable Flanks Product
- NVT Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

| | (0 | | , | | |
|---|---------------------------------------|------------------------|--------------------------------------|----------------|------|
| Parameter | | | Symbol | Value | Unit |
| Drain-to-Source Voltage | | | V _{DSS} | 30 | V |
| Gate-to-Source Voltage | | | V _{GS} | ±20 | V |
| Continuous Drain Current R _{R.IA} | | T _A = 25°C | Ι _D | 21 | A |
| (Notes 1, 2, 4) | | T _A = 100°C | | 15 | |
| Power Dissipation $R_{\theta JA}$ | | T _A = 25°C | PD | 3.1 | W |
| (Note 1, 2, 4) | Steady | T _A = 100°C | | 1.6 | |
| Continuous Drain | State | $T_A = 25^{\circ}C$ | Ι _D | 71 | |
| Current R _{θJC} (Note 1, 3, 4) | | T _A = 100°C | | 50 | A |
| Power Dissipation | | T _A = 25°C | PD | 37 | W |
| R _{θJC} (Note 1, 3, 4) | | T _A = 100°C | | 18 | |
| Pulsed Drain Current | $T_A = 25^{\circ}C, t_p = 10 \ \mu s$ | | I _{DM} | 367 | А |
| Operating Junction and Storage Temperature | | | T _J , T _{stg} | –55 to +175 | °C |
| Source Current (Body Diode) | | | ا _S | 33 | А |
| Single Pulse Drain–to–Source Avalanche Energy (T _J = 25°C, I _L = 26 A _{pk} , L = 0.1 mH) | | | E _{AS} | 34 | mJ |
| Lead Temperature for Soldering Purposes (1/8" from case for 10 s) | | | ΤL | 260 | °C |

MAXIMUM RATINGS (T_J = 25°C unless otherwise stated)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

| Parameter | Symbol | Value | Unit |
|--|-----------------------|-------|------|
| Junction-to-Case - Steady State (Drain) (Notes 1 and 4) | $R_{	extsf{	heta}JC}$ | 4.1 | °C/W |
| Junction-to-Ambient – Steady State (Notes 1 and 2) | R_{\thetaJA} | 48 | 0/11 |

- The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- 2. Surface-mounted on FR4 board using a 650 mm² 2 oz. Cu pad.
- 3. Assumes heat-sink sufficiently large to maintain constant case temperature independent of device power.
- 4. Continuous DC current rating. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

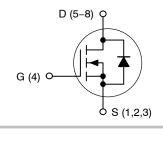


ON Semiconductor®

http://onsemi.com

| V _{(BR)DSS} | R _{DS(on)} MAX | I _D MAX |
|----------------------|-------------------------|--------------------|
| 30 V | 4.2 mΩ @ 10 V | 71 A |
| 30 V | 6.1 mΩ @ 4.5 V | |

N-Channel MOSFET



MARKING DIAGRAM sб b D XXXX WDFN8 S Γ AYWW-(µ8FL) sd CASE 511AB G h D 4C06 = Specific Device Code for NVMTS4C06N 06WF = Specific Device Code of NVTFS4C06NWF

| А | = Assembly Location |
|---|---------------------|
| | |

Y = Year WW = Work Week

= Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

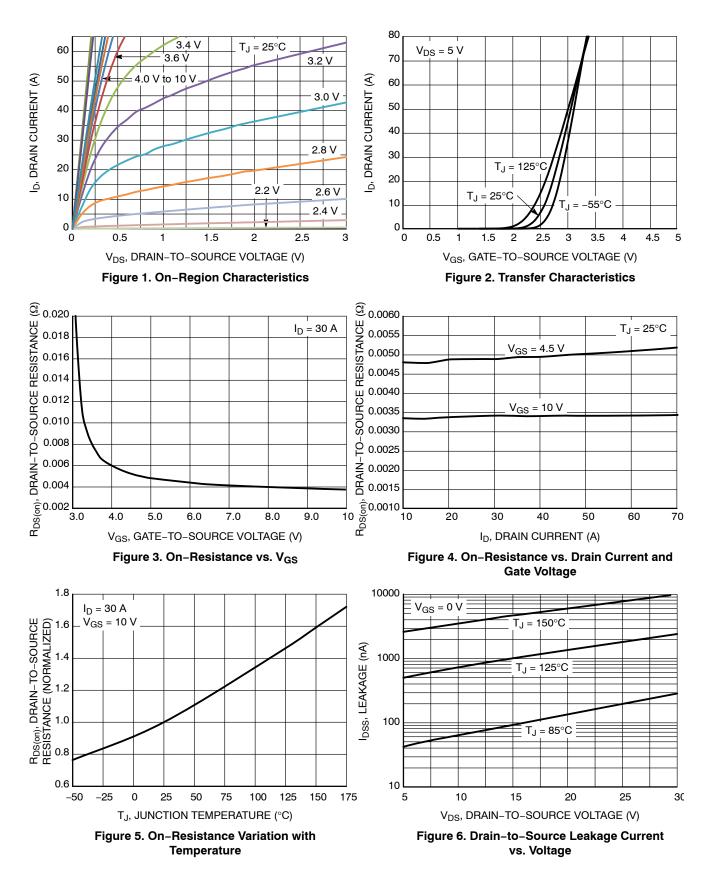
See detailed ordering and shipping information on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise specified)

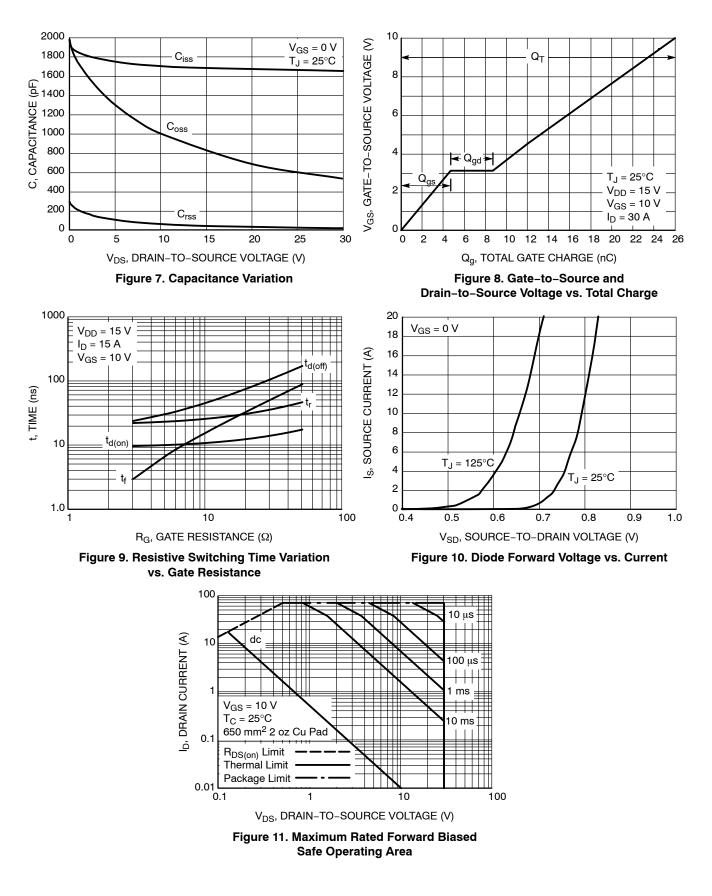
| Parameter | Symbol | Test Condition | | Min | Тур | Max | Unit | |
|--|--|--|-----------------------------|-----|-------|------|---------|--|
| OFF CHARACTERISTICS | | | | | | | | |
| Drain-to-Source Breakdown Voltage | V _{(BR)DSS} | V_{GS} = 0 V, I _D = 250 μ A | | 30 | | | V | |
| Drain-to-Source Breakdown Voltage Temperature Coefficient | V _{(BR)DSS} / T _J | | | | 14.4 | | mV/°C | |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{GS} = 0 V, V _{DS} = 24 V | $T_J = 25^{\circ}C$ | | | 1.0 | | |
| | | v _{DS} = 24 v | T _J = 125°C | | | 10 | Αμ C | |
| Gate-to-Source Leakage Current | I _{GSS} | V_{DS} = 0 V, V_{GS} | ; = ±20 V | | | ±100 | nA | |
| ON CHARACTERISTICS (Note 5) | | | | | | | | |
| Gate Threshold Voltage | V _{GS(TH)} | $V_{GS} = V_{DS}, I_D$ | = 250 μA | 1.3 | | 2.2 | V | |
| Negative Threshold Temperature Coefficient | V _{GS(TH)} /T _J | | | | 3.8 | | mV/∘C | |
| Drain-to-Source On Resistance | R _{DS(on)} | V _{GS} = 10 V | I _D = 30 A | | 3.4 | 4.2 | mΩ | |
| | | V _{GS} = 4.5 V | I _D = 30 A | | 4.9 | 6.1 | 11152 | |
| Forward Transconductance | 9fs | V _{DS} = 1.5 V, I | _D = 15 A | | 58 | | S | |
| Gate Resistance | R _G | T _A = 25° | C | | 1.0 | | Ω | |
| CHARGES AND CAPACITANCES | | | | | | | | |
| Input Capacitance | C _{ISS} | | | | 1683 | | pF | |
| Output Capacitance | C _{OSS} | V _{GS} = 0 V, f = 1 MH | z, V _{DS} = 15 V | | 841 | | | |
| Reverse Transfer Capacitance | C _{RSS} | | | | 40 | | 1 | |
| Capacitance Ratio | C _{RSS} /C _{ISS} | V _{GS} = 0 V, V _{DS} = 15 V, f = 1 MHz | | | 0.023 | | | |
| Total Gate Charge | Q _{G(TOT)} | | | | 11.6 | | 1 | |
| Threshold Gate Charge | Q _{G(TH)} | | | | 2.6 | | nC | |
| Gate-to-Source Charge | Q _{GS} | V _{GS} = 4.5 V, V _{DS} = 1 | 15 V; I _D = 30 A | | 4.7 | | | |
| Gate-to-Drain Charge | Q _{GD} | | | | 4.0 | | 1 | |
| Gate Plateau Voltage | V _{GP} | | | | 3.1 | | V | |
| Total Gate Charge | Q _{G(TOT)} | V _{GS} = 10 V, V _{DS} = 1 | 5 V; I _D = 30 A | | 26 | | nC | |
| SWITCHING CHARACTERISTICS (Note 6) | | | | | | | 8 | |
| Turn–On Delay Time | t _{d(ON)} | | | | 10 | | | |
| Rise Time | t _r | $V_{CC} = 45 V V_{C}$ | e = 15 V | | 32 | | - ns | |
| Turn–Off Delay Time | t _{d(OFF)} | V _{GS} = 4.5 V, V _D I _D = 15 A, R _G | = 3.0 Ω | | 18 | | | |
| Fall Time | t _f | | | | 5.0 | | | |
| Turn-On Delay Time | t _{d(ON)} | | | | 8.0 | | | |
| Rise Time | t _r | | e = 15 V | | 28 | | 1 | |
| Turn-Off Delay Time | t _{d(OFF)} | V_{GS} = 10 V, V_{DS} = 15 V, I_{D} = 15 A, R_{G} = 3.0 Ω | | | 24 | | ns | |
| Fall Time | t _f | | | | 3.0 | | | |
| DRAIN-SOURCE DIODE CHARACTERISTIC | | | | | | 1 | 1 | |
| Forward Diode Voltage | V _{SD} | V _{GS} = 0 V, | T _J = 25°C | | 0.8 | 1.1 | V | |
| | | V _{GS} = 0 V, I _S = 10 A | T _J = 125°C | | 0.63 | | | |
| Reverse Recovery Time | t _{RR} | V _{GS} = 0 V, dlS/dt = 100 A/µs, I _S = 30 A | | | 34 | | | |
| Charge Time | ta | | | | 17 | | ns | |
| Discharge Time | t _b | | | | 17 | | • | |
| Reverse Recovery Charge | Q _{RR} | | | | 22 | | nC | |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 5. Pulse Test: pulse width \leq 300 µs, duty cycle \leq 2%. 6. Switching characteristics are independent of operating junction temperatures.

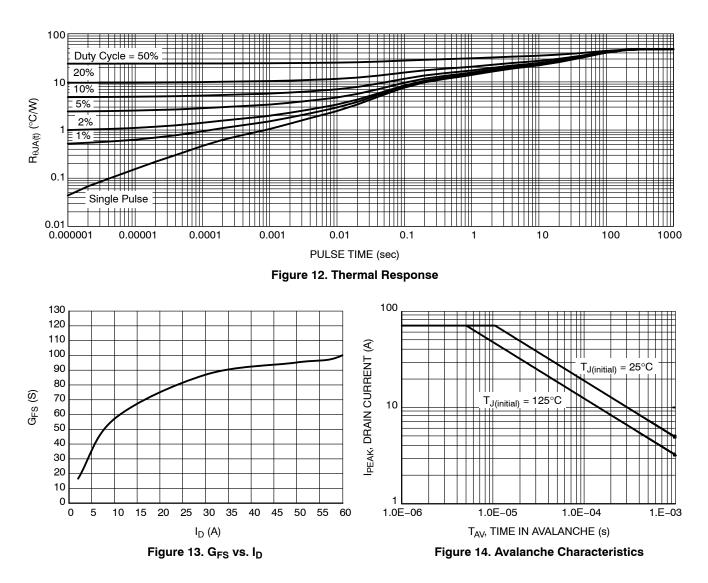
TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



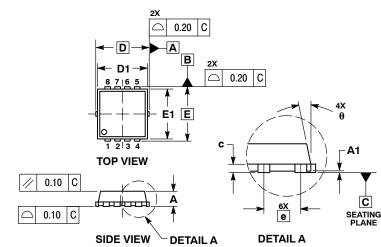
ORDERING INFORMATION

| Device | Package | Shipping [†] |
|-----------------|--------------------|-----------------------|
| NVTFS4C06NTAG | WDFN8 (Pb-Free) | 1500 / Tape & Reel |
| NVTFS4C06NWFTAG | WDFN8 (Pb-Free) | 1500 / Tape & Reel |
| NVTFS4C06NTWG | WDFN8 (Pb-Free) | 5000 / Tape & Reel |
| NVTFS4C06NWFTWG | WDFN8 (Pb-Free) | 5000 / Tape & Reel |

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

WDFN8 3.3x3.3, 0.65P CASE 511AB ISSUE D



3. DIMENSION D1 AND E1 DO NOT INCLUDE MOLD FLASH PROTRUSIONS OR GATE BURRS. MILLIMETERS INCHES

NOTES:

| | MILLIMETERS | | | INCHES | | | |
|-----|-------------|----------|------|-----------|----------|-------|--|
| DIM | MIN | NOM | MAX | MIN | NOM | MAX | |
| Α | 0.70 | 0.75 | 0.80 | 0.028 | 0.030 | 0.031 | |
| A1 | 0.00 | | 0.05 | 0.000 | | 0.002 | |
| b | 0.23 | 0.30 | 0.40 | 0.009 | 0.012 | 0.016 | |
| с | 0.15 | 0.20 | 0.25 | 0.006 | 0.008 | 0.010 | |
| D | | 3.30 BSC | | 0 | .130 BSC | ; | |
| D1 | 2.95 | 3.05 | 3.15 | 0.116 | 0.120 | 0.124 | |
| D2 | 1.98 | 2.11 | 2.24 | 0.078 | 0.083 | 0.088 | |
| Е | | 3.30 BSC | | 0.130 BSC | | | |
| E1 | 2.95 | 3.05 | 3.15 | 0.116 | 0.120 | 0.124 | |
| E2 | 1.47 | 1.60 | 1.73 | 0.058 | 0.063 | 0.068 | |
| E3 | 0.23 | 0.30 | 0.40 | 0.009 | 0.012 | 0.016 | |
| е | 0.65 BSC | | | 0.026 BSC | | | |
| G | 0.30 | 0.41 | 0.51 | 0.012 | 0.016 | 0.020 | |
| к | 0.65 | 0.80 | 0.95 | 0.026 | 0.032 | 0.037 | |
| L | 0.30 | 0.43 | 0.56 | 0.012 | 0.017 | 0.022 | |
| L1 | 0.06 | 0.13 | 0.20 | 0.002 | 0.005 | 0.008 | |
| М | 1.40 | 1.50 | 1.60 | 0.055 | 0.059 | 0.063 | |
| θ | 0 ° | | 12 ° | 0 ° | | 12 ° | |

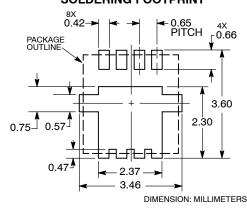
DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
CONTROLLING DIMENSION: MILLIMETERS.

С В 0.10 А 0.05 С e/2 4X Ā É2 E3 м ¥ D2 G **BOTTOM VIEW**

8X

 \oplus

SOLDERING FOOTPRINT*



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ON Semiconductor and **W** are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of SCILLC's product/patent coverage may be accessed at www.onsemic.com/site/pdf/Patent-Marking.pdf. SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typical" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components instended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death massociated with such unintended or unauthorized applicable copyright as mediane tregarding the design or manufacture of the pert. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support:

Phone: 421 33 790 2910 Japan Customer Focus Center Phone: 81-3-5817-1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by ON Semiconductor manufacturer:

Other Similar products are found below :

614233C 648584F MCH3443-TL-E MCH6422-TL-E FDPF9N50NZ FW216A-TL-2W FW231A-TL-E APT5010JVR NTNS3A92PZT5G IRF100S201 JANTX2N5237 2SK2464-TL-E 2SK3818-DL-E FCA20N60_F109 FDZ595PZ STD6600NT4G FSS804-TL-E 2SJ277-DL-E 2SK1691-DL-E 2SK2545(Q,T) D2294UK 405094E 423220D MCH6646-TL-E TPCC8103,L1Q(CM 367-8430-0972-503 VN1206L 424134F 026935X 051075F SBVS138LT1G 614234A 715780A NTNS3166NZT5G 751625C 873612G IRF7380TRHR IPS70R2K0CEAKMA1 RJK60S3DPP-E0#T2 RJK60S5DPK-M0#T0 APT5010JVFR APT12031JFLL APT12040JVR DMN3404LQ-7 NTE6400 JANTX2N6796U JANTX2N6784U JANTXV2N5416U4 SQM110N05-06L-GE3 SIHF35N60E-GE3